# BLF6G10L-260PRN; BLF6G10LS-260PRN Power LDMOS transistor

Rev. 3 — 1 September 2015



#### **Product profile** 1.

### 1.1 General description

260 W LDMOS power transistor for base station applications at frequencies from 700 MHz to 1000 MHz.

#### Table 1. **Typical performance**

Typical RF performance at  $T_{case} = 25 \ ^{\circ}C$  in a class-AB production test circuit.

Mode of operation	f	$V_{DS}$	P <sub>L(AV)</sub>	Gp	$\eta_D$	ACPR	
	(MHz)	(V)	(W)	(dB)	(%)	(dBc)	
2-carrier W-CDMA	920 to 960	28	40	22.0	26.5	-39 <mark>[1]</mark>	

[1] Test signal: 3GPP test model 1; 1 to 64 DPCH; PAR = 7.5 dB at 0.01 % probability on CCDF per carrier; carrier spacing 5 MHz.

#### CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Therefore care should be taken during transport and handling.

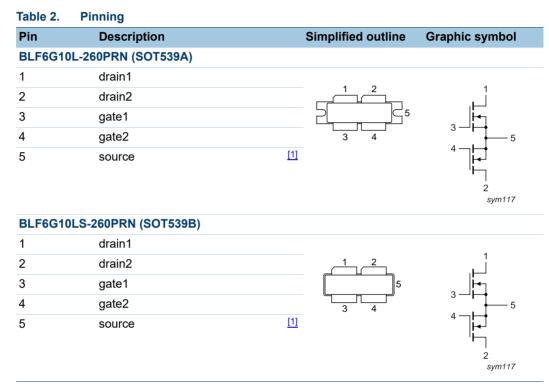
#### 1.2 Features and benefits

- Typical 2-carrier W-CDMA performance at frequencies of 920 MHz and 960 MHz, a supply voltage of 28 V and an  $I_{Dq}$  of 1800 mA:
  - Average output power = 40 W
  - Power gain = 22.0 dB
  - Efficiency = 26.5 %
  - ◆ ACPR = -39 dBc
- Easy power control
- Integrated ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (700 MHz to 1000 MHz)
- Internally matched for ease of use
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

### 1.3 Applications

RF power amplifiers for GSM, GSM EDGE, W-CDMA and CDMA base stations and multi carrier applications in the 700 MHz to 1000 MHz frequency range

### 2. Pinning information



[1] Connected to flange.

### 3. Ordering information

Table 3.         Ordering information						
Type number	Packag	Package				
	Name	Description	Version			
BLF6G10L-260PRN	-	flanged balanced LDMOST ceramic package; 2 mounting holes; 4 leads	SOT539A			
BLF6G10LS-260PRN	-	earless flanged balanced LDMOST ceramic package; 4 leads	SOT539B			

### 4. Limiting values

Table 4. In accordar	Limiting values nce with the Absolute Maxi	mum Rating System (IEC 60134).			
Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>DS</sub>	drain-source voltage		-	65	V
V <sub>GS</sub>	gate-source voltage		-0.5	+13	V
I <sub>D</sub>	drain current		-	64	А
T <sub>stg</sub>	storage temperature		-65	+150	°C
Тj	junction temperature		-	200	°C

### 5. Thermal characteristics

Table 5.	Thermal characteristics			
Symbol	Parameter	Conditions	Тур	Unit
R <sub>th(j-case)</sub>	thermal resistance from junction to case	$T_{case}$ = 80 °C; $P_L$ = 40 W	0.28	K/W

### 6. Characteristics

#### Table 6. Characteristics

 $T_i = 25$  °C; values per section unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V <sub>(BR)DSS</sub>	drain-source breakdown voltage	V <sub>GS</sub> = 0 V; I <sub>D</sub> = 1.8 mA	65	-	-	V
V <sub>GS(th)</sub>	gate-source threshold voltage	$V_{DS}$ = 10 V; $I_{D}$ = 180 mA	1.4	1.9	2.4	V
$V_{GSq}$	gate-source quiescent voltage	V <sub>DS</sub> = 28 V; I <sub>D</sub> = 1000 mA	1.45	2.1	2.55	V
I <sub>DSS</sub>	drain leakage current	$V_{GS}$ = 0 V; $V_{DS}$ = 28 V	-	-	2.8	μA
I <sub>DSX</sub>	drain cut-off current	$\label{eq:VGS} \begin{array}{l} V_{\mathrm{GS}} = V_{\mathrm{GS(th)}} + 3.75 \ V; \\ V_{\mathrm{DS}} = 10 \ V \end{array}$	24.1	30	-	A
I <sub>GSS</sub>	gate leakage current	$V_{GS}$ = 11 V; $V_{DS}$ = 0 V	-	-	280	nA
g <sub>fs</sub>	forward transconductance	$V_{DS}$ = 10 V; I <sub>D</sub> = 9 A	7.02	12	-	S
R <sub>DS(on)</sub>	drain-source on-state resistance	$V_{GS} = V_{GS(th)} + 3.75 V;$ $I_D = 6.3 A$	0.053	0.1	0.165	Ω

### 7. Application information

#### Table 7. 2-carrier W-CDMA Application information

Class-AB production test circuit; PAR 7.5 dB at 0.01 % probability on CCDF; 3GPP test model 1; 1 to 64 DPCH;  $f_1 = 917.5$  MHz;  $f_2 = 922.5$  MHz;  $f_3 = 957.5$  MHz;  $f_4 = 962.5$  MHz; RF performance at  $V_{DS} = 28$  V;  $I_{Dq} = 1800$  mA;  $T_{case} = 25$  °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Мах	Unit
P <sub>L(AV)</sub>	average output power		-	40	-	W
G <sub>p</sub>	power gain	$P_{L(AV)} = 40 W$	19.8	22.0	-	dB

#### Table 7. 2-carrier W-CDMA Application information ...continued

Class-AB production test circuit; PAR 7.5 dB at 0.01 % probability on CCDF; 3GPP test model 1; 1 to 64 DPCH;  $f_1 = 917.5$  MHz;  $f_2 = 922.5$  MHz;  $f_3 = 957.5$  MHz;  $f_4 = 962.5$  MHz; RF performance at  $V_{DS} = 28$  V;  $I_{Da} = 1800$  mA;  $T_{case} = 25$  °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
RL <sub>in</sub>	input return loss	P <sub>L(AV)</sub> = 40 W	-	-10.0	-6.0	dB
$\eta_D$	drain efficiency	$P_{L(AV)} = 40 W$	25.0	26.5	-	%
ACPR	adjacent channel power ratio	$P_{L(AV)} = 40 W$	-	-39	-35	dBc

#### Table 8. 1 carrier W-CDMA Application information

Class-AB production test circuit; PAR 7.5 dB at 0.01 % probability on CCDF; 3 GPP test model 1; 1 to 64 DPCH;  $f_1 = 960$  MHz; RF performance at VDS = 28 V;  $I_{dq}$  1800 mA;  $T_{case} = 25$  °C; unless otherwise specified.

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
PAR <sub>0</sub>	output peak-to-average ratio	PL(AV) = 125 W at 0.01 % probability on CCDF	3.8	4.3	-	dB

#### 7.1 Ruggedness in class-AB operation

The BLF6G10L-260PRN and BLF6G10L-260PRN are capable of withstanding a load mismatch corresponding to VSWR = 10 : 1 through all phases under the following conditions:  $V_{DS} = 28 \text{ V}$ ;  $I_{Da} = 1800 \text{ mA}$ ;  $P_L = 260 \text{ W}$  (CW); f = 920 MHz to 960 MHz.

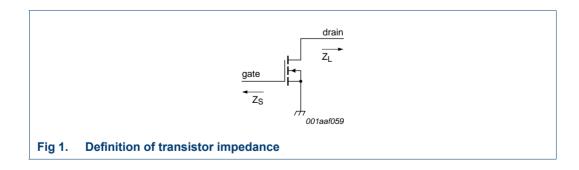
#### 7.2 Impedance information

#### Table 9. Typical impedance per section

 $I_{Dg} = 950 \text{ mA}$ ; main transistor  $V_{DS} = 28 \text{ V}$ 

Eq ,	20		
f	Z <sub>S</sub> [1]	Z <sub>L</sub> [1]	
MHz	Ω	Ω	
920	0.7 – j1.0	1.4 + j0.6	
940	1.1 – j1.3	1.2 + j0.5	
960	1.0 – j1.6	1.2 + j0.3	

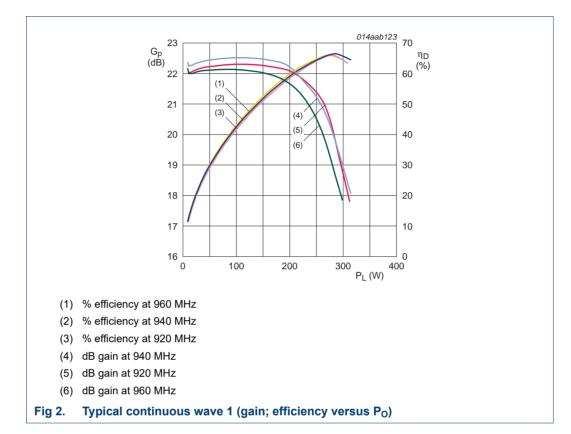
[1]  $Z_S$  and  $Z_L$  defined in Figure 1.

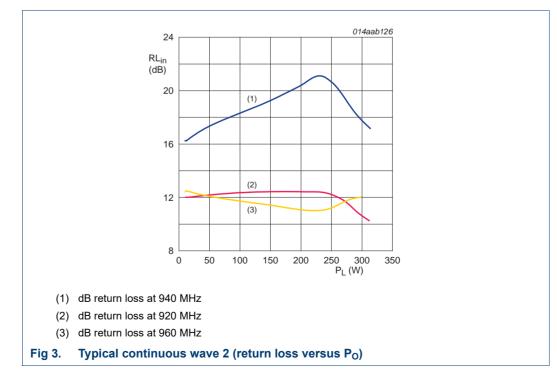


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#### 7.3 Typical powersweep

#### 7.3.1 CW



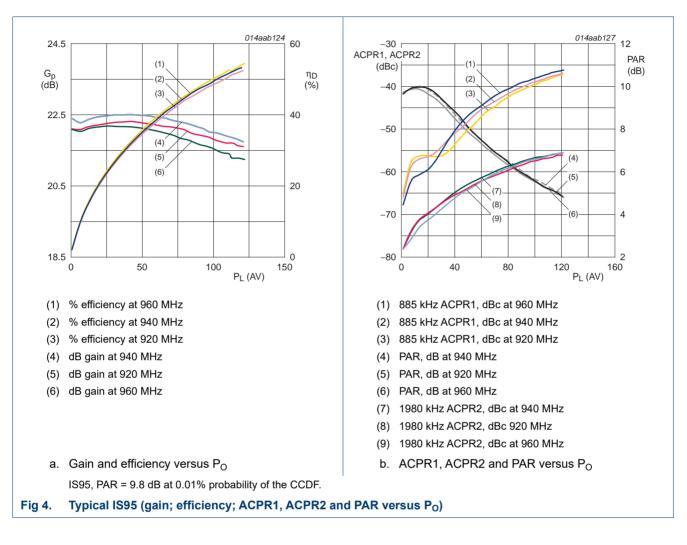


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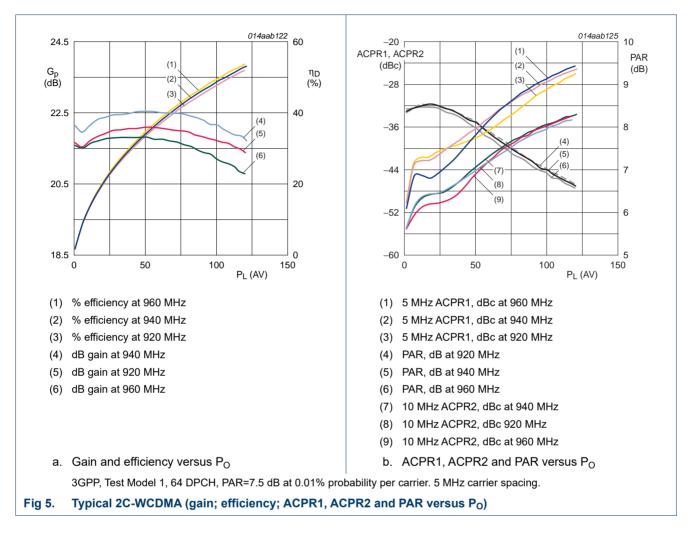
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7.3.2 IS95



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#### 7.3.3 2C-WCDMA (5 MHz spacing)

### 8. Test information

#### 8.1 Test circuit

Figure 6 shows the PCB test circuit layout

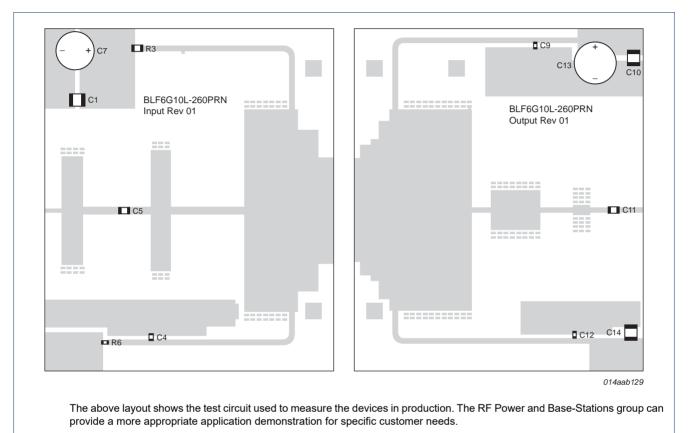


Fig 6. Input and output test circuit PCBs'

#### 8.2 Bill of materials (B.O.M.)

The following Bill of materials (<u>Table 10</u>) shows a list of all the components needed to build the RF test circuit.

Component	Description	Туре	Value	Code number	Remarks
	base plate				see mechanical drawing.
	input PCB				see PCB info.
	output PCB				see PCB info.
	$15 \times bolt M2$				brass (nickel plated)
	$15 \times \text{washer M2}$				brass (nickel plated)
	$4 \times \text{contact block}$		$12 \times 4 \text{ mm}$		brass (milled)
	rubber O-ring	Viton	$17 \times 1 \text{ mm}$		
	conductive elastomer ("silver" rubber)	Chomerics	35 × 1 mm (2x)	CHO-SEAL 1273	

#### Table 10.Bill of materials

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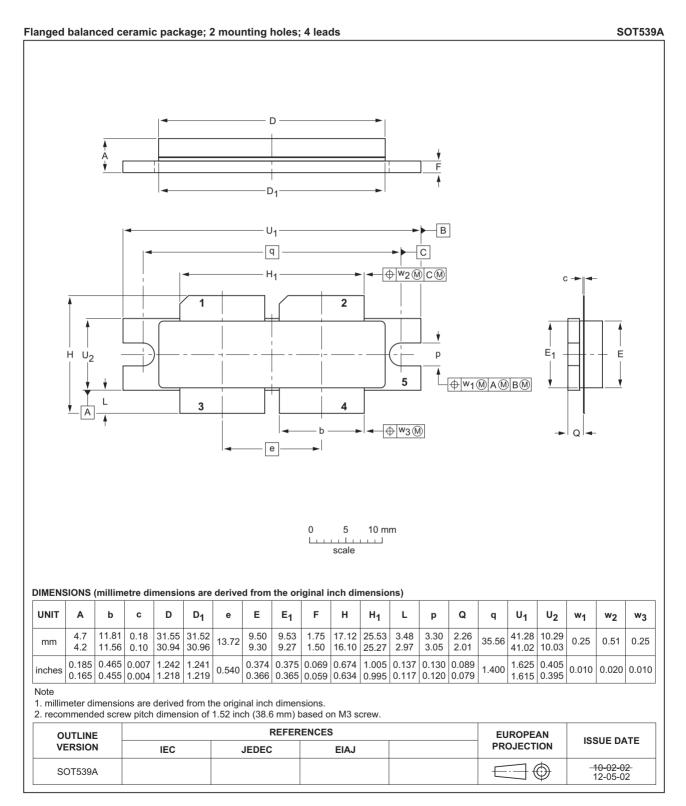
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#### Table 10. Bill of materials ... continued

Component	Description	Туре	Value	Code number	Remarks
C4, C5, C9, C11, C12	multilayer ceramic chip capacitor	ATC 800B	100 pF		
	multilayer ceramic chip capacitor				
C1, C10, C14	multilayer ceramic chip capacitor	TDK	10 μF		
C7, C13	electrolytic capacitor		470 μF		
R3, R6	chip resistor	Philips 0603	10 Ω		
	copper foil strip				needed for tuning
	standard components:				
	N-connector male	13N-50-057/1			Suhner
	N-connector female	23N-50-057/1			Suhner
	$4 \times bolt M3$		12 mm		chromium nickle steel
	$4 \times spring$ washer M3				chromium nickle steel
	DC-connector 8 pin male	8140-115			Souriau (Farnell)
	$2 \times DC$ -connector 2 pin male	8140-12			Souriau (Farnell)
	$2 \times bolt M3$		30 mm		chromium nickle steel
	$2 \times \text{washer M3}$				chromium nickle steel
	solid copper wire (diam. 1 mm)		30 mm		
	flexible copper wire	SIMX-F	0.75 mm <sup>2</sup>		silicon isolated
	$4 \times cable isolator (diam. 3 mm)$	P/H30X15WE		1922.000.10134	
	$4 \times cable isolator (diam. 2 mm)$	P/H20X10WE		1922.000.10033	

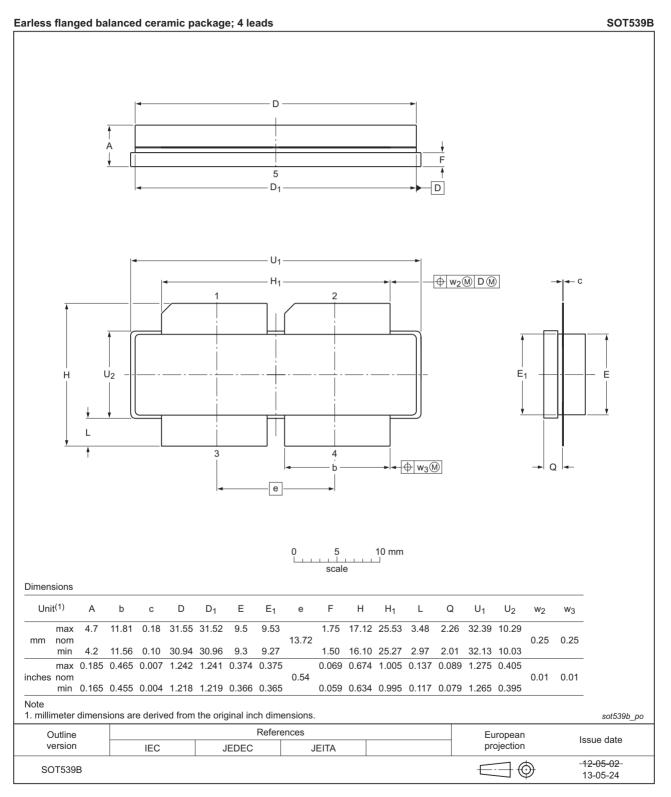
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### 9. Package outline



#### Fig 7. Package outline SOT539A

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#### Fig 8. Package outline SOT539B

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### **10. Abbreviations**

Table 11.	Abbreviations
Acronym	Description
3GPP	Third Generation Partnership Project
CCDF	Complementary Cumulative Distribution Function
CDMA	Code Division Multiple Access
CW	Continuous Wave
DPCH	Dedicated Physical CHannel
EDGE	Enhanced Data rates for GSM Evolution
GSM	Global System for Mobile communications
LDMOS	Laterally Diffused Metal-Oxide Semiconductor
LDMOST	Laterally Diffused Metal-Oxide Semiconductor Transistor
PAR	Peak-to-Average power Ratio
RF	Radio Frequency
VSWR	Voltage Standing-Wave Ratio
W-CDMA	Wideband Code Division Multiple Access

### 11. Revision history

#### Table 12.Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BLF6G10L-260PRN_LS-260PRN#3	20150901	Product data sheet	-	BLF6G10L-260PRN_LS-260PRN v.2	
Modifications:	<ul> <li>The format of this document has been redesigned to comply with the new identity guidelines of Ampleon.</li> <li>Legal texts have been adapted to the new company name where appropriate.</li> </ul>				
BLF6G10L-260PRN_LS-260PRN v.2	20130712	Product data sheet	-	BLF6G10L-260PRN_LS-260PRN v.1	
BLF6G10L-260PRN_LS-260PRN v.1	20100812	Product data sheet	-	-	

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Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
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**Product data sheet** 

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Date of release: 1 September 2015 Document identifier: BLF6G10L-260PRN\_LS-260PRN#3